

Surface Mount Fast Recovery Rectifiers

Reverse Voltage - 50 to 1000 V

Forward Current - 2 A

FEATURES

- ◆ For surface mounted applications
- ◆ Low profile package
- ◆ Glass Passivated Chip Junction
- ◆ Easy to pick and place
- ◆ Fast reverse recovery time
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

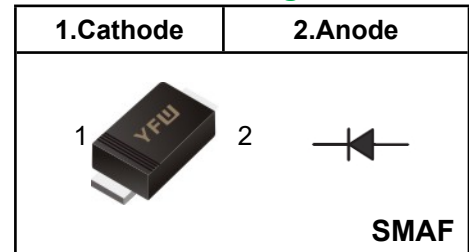
- ◆ Case: SMAF
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 27mg / 0.00095oz

Absolute Maximum Ratings and characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Pinning



Marking Code

RS2AF	YFW RS2A
RS2BF	YFW RS2B
RS2DF	YFW RS2D
RS2GF	YFW RS2G
RS2JF	YFW RS2J
RS2KF	YFW RS2K
RS2MF	YFW RS2M

Parameter	Symbols	RS2AF	RS2BF	RS2DF	RS2GF	RS2JF	RS2KF	RS2MF	Units	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current at $T_c = 125\text{ }^\circ\text{C}$	$I_{F(AV)}$	2							A	
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	50							A	
Maximum Instantaneous Forward Voltage at 2 A	V_F	1.3							V	
Maximum DC Reverse Current $T_a = 25\text{ }^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125\text{ }^\circ\text{C}$	I_R	5 100							μA	
Typical Junction Capacitance at $V_R=4\text{V}, f=1\text{MHz}$	C_j	22							pF	
Maximum Reverse Recovery Time ⁽¹⁾	T_{rr}	150				250		500		nS
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA} / R_{\theta JC}$	65/20							$^\circ\text{C/W}$	
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150							$^\circ\text{C}$	

(1) Measured with $I_F=0.5\text{A}, I_R=1\text{A}, I_n=0.25\text{A}$

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

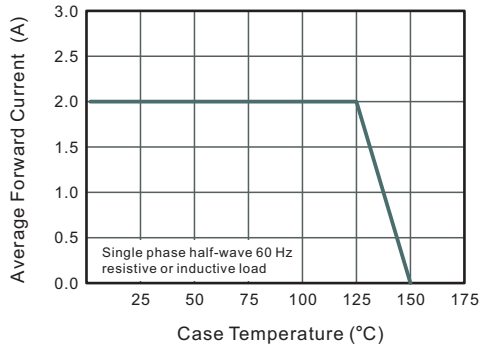


Fig.2 Typical Reverse Characteristics

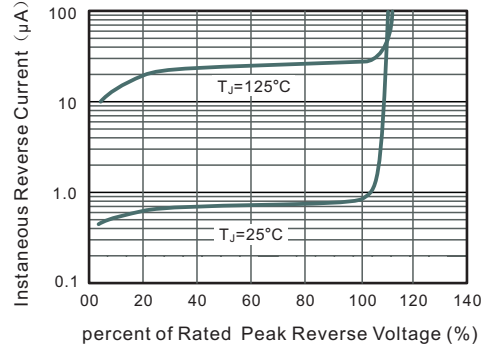


Fig.3 Typical Instantaneous Forward Characteristics

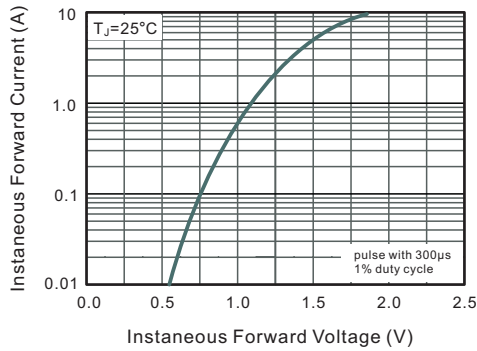


Fig.4 Typical Junction Capacitance

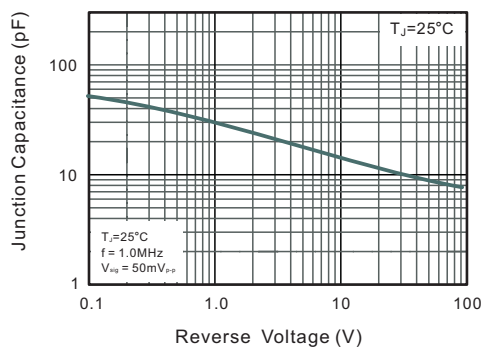
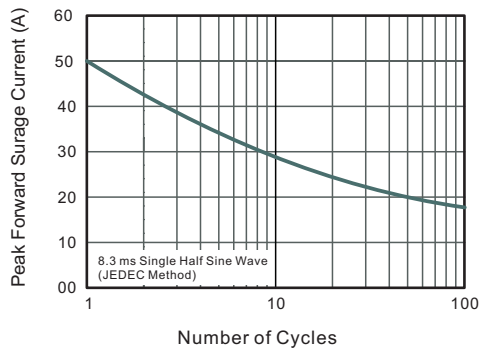


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



Marking Diagram



Ordering information

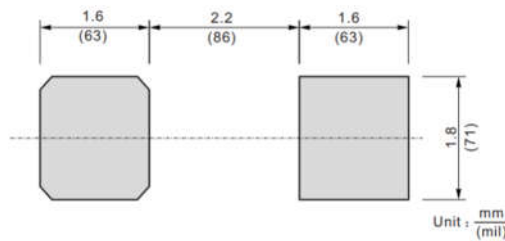
Package	Packing Description	Packing Quantity
SMAF	Tape/Reel,7"reel	3000PCS/Reel 90000PCS/Carton

Package Dimensions

SMAF

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	0.9	1.1	35	43
C	0.12	0.20	4.7	7.9
D	3.3	3.7	130	146
E	2.4	2.7	94	106
e	1.3	1.6	51	63
g	0.8	1.2	31	47
HE	4.4	4.9	173	193
∠	7°			

The recommended mounting pad size



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